

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takehiko Shibazaki	01/18/2011
RECEIVING PARTY DATA	
Name:	Sundance Enterprises Inc.
Street Address:	5-24-9 Kamiyoga, Setagaya-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	158-0098
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13013621
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ATTORNEY DOCKET NUMBER:	42598-8000
NAME OF SUBMITTER:	Joseph W. Price
Total Attachments: 2 source=42598-8000_Assignment#page1.tif source=42598-8000_Assignment#page2.tif	

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ASSIGNMENT

WHEREAS, I, Takehiko Shibazaki, a citizen of Japan, have invented certain new and useful improvements in INTAKE MANIFOLD FLANGE, for which I have executed application for Letters Patent of the United States, filed (authorization is given herewith to insert the application serial number and filing date when it becomes available) as U.S. Serial No. 13/013,621 filed on 1/25/2011; and

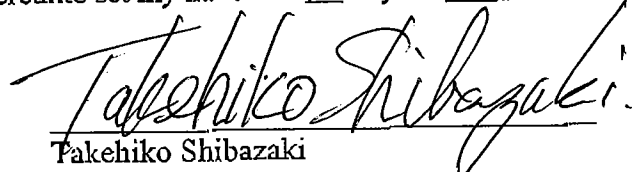
WHEREAS, SUNDANCE ENTERPRISES INC., a corporation of Japan, having a principal place of business at 5-24-9 Kamiyoga, Setagaya-ku, Tokyo, 158-0098 Japan, is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application,

NOW, THEREFORE, in consideration of the sum of One Hundred Yen (100 ¥) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I, Takehiko Shibazaki, have sold, assigned, transferred and set over, unto said Tamura Corporation, its successors, legal representatives and assigns, the entire right, title and interest in, to and under said improvements, and said application and all divisions, renewals and continuations thereof, and all Letters Patents of the United States, which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every country of the Union, and all applications for Letters Patents which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States, and any official of any country or countries foreign to the United States, whose duty it is to issue patents, on applications as aforesaid, to issue all Letters Patents for said improvements to said Tamura Corporation, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to said Tamura Corporation, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Tamura Corporation, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 18 day of January, 2011.


Takehiko Shibazaki